Small Signal MOSFET

30 V, 250 mA, Dual N-Channel, SC-88

Features

- Low Gate Charge for Fast Switching
- Small Footprint 30% Smaller than TSOP–6
- ESD Protected Gate
- AEC Q101 Qualified NVTJD4001N
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Low Side Load Switch
- Li-Ion Battery Supplied Devices Cell Phones, PDAs, DSC
- Buck Converters
- Level Shifts

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

| Param | Symbol | Value | Units | | |
|---|-----------------|------------------------|-----------------------------------|---------------|----|
| Drain-to-Source Voltage | | | V_{DSS} | 30 | V |
| Gate-to-Source Voltage | V _{GS} | ±20 | V | | |
| Continuous Drain Steady Current (Note 1) State | | T _A = 25 °C | I _D | 250 | mA |
| | | T _A = 85 °C | | 180 | |
| Power Dissipation Steady (Note 1) State | | T _A = 25 °C | P _D | 272 | mW |
| Pulsed Drain Current | I _{DM} | 600 | mA | | |
| Operating Junction and Storage Temperature | | | T _J , T _{STG} | –55 to 150 | °C |
| Source Current (Body Diode) | | | Is | 250 | mA |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | | T_L | 260 | °C |

THERMAL RESISTANCE RATINGS (Note 1)

| Parameter | Symbol | Value | Unit |
|------------------------------------|-----------------|-------|------|
| Junction-to-Ambient - Steady State | $R_{\theta JA}$ | 458 | °C/W |
| Junction-to-Lead - Steady State | $R_{\theta JL}$ | 252 | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

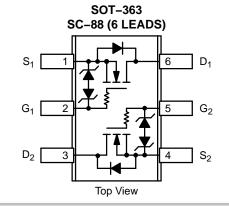
1. Surface mounted on FR4 board using min pad size (Cu area = 0.155 in sq [1 oz] including traces).



ON Semiconductor®

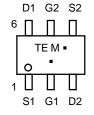
www.onsemi.com

| V _{(BR)DSS} | V _{(BR)DSS} R _{DS(on)} TYP | |
|----------------------|--|----------|
| 30 V | 1.0 Ω @ 4.0 V | 250 mA |
| | 1.5 Ω @ 2.5 V | 250 IIIA |



MARKING DIAGRAM & PIN ASSIGNMENT





TE = Device Code

M = Date Code

Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------------|----------------------|-----------------------|
| NTJD4001NT1G | SOT-363 (Pb-Free) | 3000 / Tape & Reel |
| NVTJD4001NT1G | SOT-363 (Pb-Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

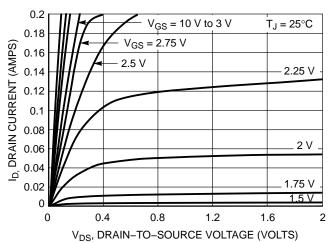
ELECTRICAL CHARACTERISTICS (T₁ = 25°C unless otherwise stated)

| Parameter | Symbol | Test Con | dition | Min | Тур | Max | Unit |
|--|--------------------------------------|--|-------------------------|-----|------|------|--------|
| OFF CHARACTERISTICS | | | <u> </u> | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0 \text{ V, } I_{D}$ | 30 | | | V | |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} /T _J | | | | | | mV/ °C |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, V | _{DS} = 30 V | | | 1.0 | μΑ |
| Gate-to-Source Leakage Current | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{C}$ | _{GS} = ±10 V | | | ±1.0 | μΑ |
| ON CHARACTERISTICS (Note 2) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS}, I_{I}$ | ο = 100 μΑ | 8.0 | 1.2 | 1.5 | V |
| Gate Threshold Temperature Coefficient | V _{GS(TH)} /T _J | | | | -3.2 | | mV/ °C |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 4.0 V, I _D = 10 mA | | | 1.0 | 1.5 | Ω |
| | | V _{GS} = 2.5 V, | I _D = 10 mA | | 1.5 | 2.5 | |
| Forward Transconductance | g _{FS} | V _{DS} = 3.0 V, | _D = 10 mA | | 80 | | mS |
| CHARGES AND CAPACITANCES | | | | | | | |
| Input Capacitance | C _{ISS} | $V_{GS} = 0 \text{ V, f} = 1.0 \text{ MHz,}$ $V_{DS} = 5.0 \text{ V}$ | | | 20 | 33 | pF |
| Output Capacitance | C _{OSS} | | | | 19 | 32 | |
| Reverse Transfer Capacitance | C _{RSS} | | | | 7.25 | 12 | |
| Total Gate Charge | Q _{G(TOT)} | $V_{GS} = 5.0 \text{ V}, \text{ V}$ $I_{D} = 0.0 \text{ V}$ | / _{DS} = 24 V, | | 0.9 | 1.3 | nC |
| Threshold Gate Charge | Q _{G(TH)} | $I_D = 0$. | 1 A | | 0.2 | | |
| Gate-to-Source Charge | Q _{GS} | | | | 0.3 | | |
| Gate-to-Drain Charge | Q_{GD} | | | | 0.2 | | |
| SWITCHING CHARACTERISTICS (No | ote 3) | | | | | | |
| Turn-On Delay Time | td _(ON) | V _{GS} = 4.5 V, V | | | 17 | | ns |
| Rise Time | tr | $I_D = 10$ mA, $R_G = 50 \Omega$ | | | 23 | | |
| Turn-Off Delay Time | td _(OFF) | | | | 94 | | |
| Fall Time | tf | | | | 82 | | |
| DRAIN-SOURCE DIODE CHARACTE | RISTICS | | | | | | • |
| Forward Diode Voltage | V _{SD} | V _{GS} = 0 V, | T _J = 25°C | | 0.65 | 0.7 | V |
| | | $I_S = 10 \text{ mA}$ | T _J = 125°C | | 0.45 | | |
| Reverse Recovery Time | t _{RR} | $V_{GS} = 0 \text{ V, } dI_S/dt = 8.0 \text{ A/}\mu\text{s,}$ $I_S = 10 \text{ mA}$ | | | 12.4 | | ns |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 2. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%. 3. Switching characteristics are independent of operating junction temperatures.

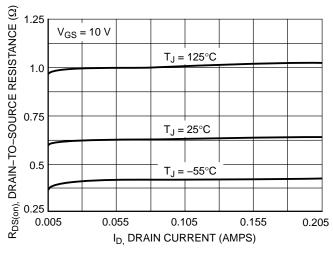
TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



 $V_{DS} = 5 V$ ID, DRAIN CURRENT (AMPS) 0.08 0.06 $T_J = 125^{\circ}C$ 0.04 0.02 $T_J = -55^{\circ}C$ 0 1.2 1.4 1.6 2.2 1 1.8 2 V_{GS}, GATE-TO-SOURCE VOLTAGE (VOLTS)

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



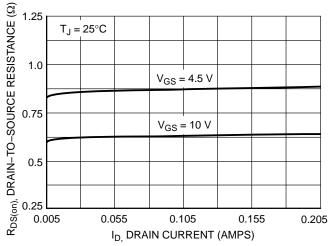
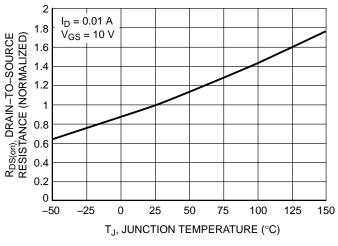


Figure 3. On–Resistance vs. Drain Current and Temperature

Figure 4. On-Resistance vs. Drain Current and Gate Voltage



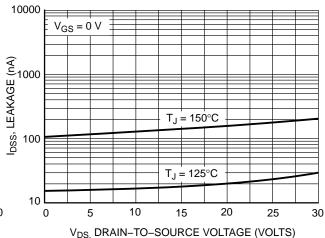
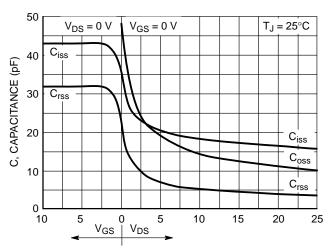
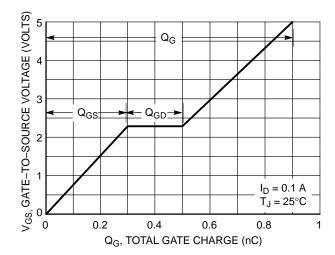


Figure 5. On–Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)





GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS)

Figure 7. Capacitance Variation

Figure 8. Gate-to-Source Voltage vs. Total Gate Charge

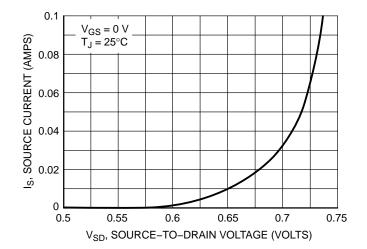


Figure 9. Diode Forward Voltage vs. Current

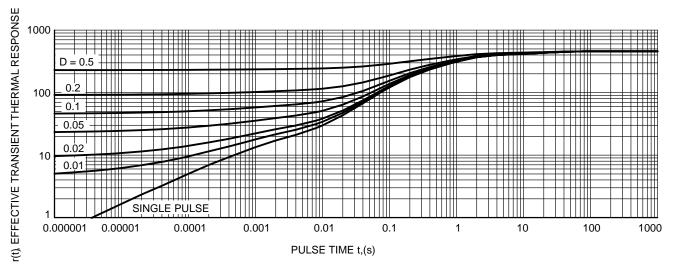
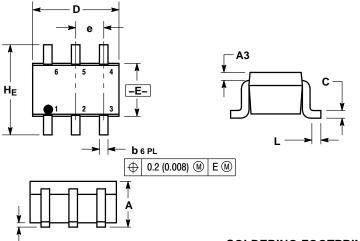


Figure 10. Thermal Response

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363

CASE 419B-02 **ISSUE W**



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH
- 419B-01 OBSOLETE, NEW STANDARD 419B-02.

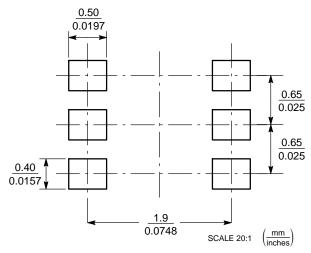
| | MIL | LIMETE | ERS | INCHES | | | |
|-----|----------|--------|------|-----------|-------|-------|--|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX | |
| Α | 0.80 | 0.95 | 1.10 | 0.031 | 0.037 | 0.043 | |
| A1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 | |
| А3 | 0.20 REF | | | 0.008 REF | | | |
| b | 0.10 | 0.21 | 0.30 | 0.004 | 0.008 | 0.012 | |
| С | 0.10 | 0.14 | 0.25 | 0.004 | 0.005 | 0.010 | |
| D | 1.80 | 2.00 | 2.20 | 0.070 | 0.078 | 0.086 | |
| E | 1.15 | 1.25 | 1.35 | 0.045 | 0.049 | 0.053 | |
| е | 0.65 BSC | | | 0.026 BSC | | | |
| L | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 | |
| HE | 2.00 | 2.10 | 2.20 | 0.078 | 0.082 | 0.086 | |

STYLE 26:

- PIN 1. SOURCE 1 2. GATE 1

 - DRAIN 2 SOURCE 2
 - GATE 2 DRAIN 1

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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